# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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### Switch-mode Power Rectifier 60 V, 20 A

#### Features and Benefits

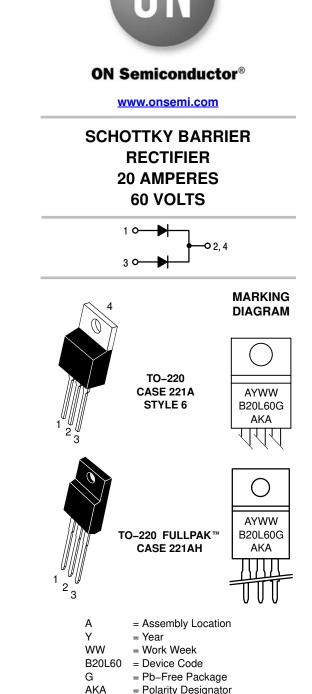
- Low Power Loss/High Efficiency
- High Surge Capacity
- 20 A Total (10 A Per Diode Leg)
- Guard-Ring for Stress Protection
- These Devices are Pb-Free and are RoHS Compliant\*

#### Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube



#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR20L60CTG	TO–220 (Pb–Free)	50 Units / Rail
MBRF20L60CTG	TO–220FP (Pb–Free)	50 Units / Rail

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### MAXIMUM RATINGS (Per Diode Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward CurrentMBR20L60CT (Rated $V_R$ ) $T_C = 138^{\circ}C$ Per DiodeMBRF20L60CT (Rated $V_R$ ) $T_C = 123^{\circ}C$ Per Device	I <sub>F(AV)</sub>	10 20	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	240	A
Operating Junction Temperature (Note 1)	TJ	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C
ESD Ratings: Machine Model = C Human Body Model = 3B		> 400 > 8000	V
Maximum Repetitive Peak Avalanche Voltage ( $t_p < 1 \ \mu s, T_J < 150^{\circ}$ C, I <sub>AR</sub> < 51 A)	V <sub>ARM</sub>	85	V
Maximum Single–Pulse Peak Avalanche Voltage $(t_p < 1 \ \mu s, T_J < 150^{\circ}C, I_{AR} < 51 \ A)$	V <sub>ASM</sub>	85	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

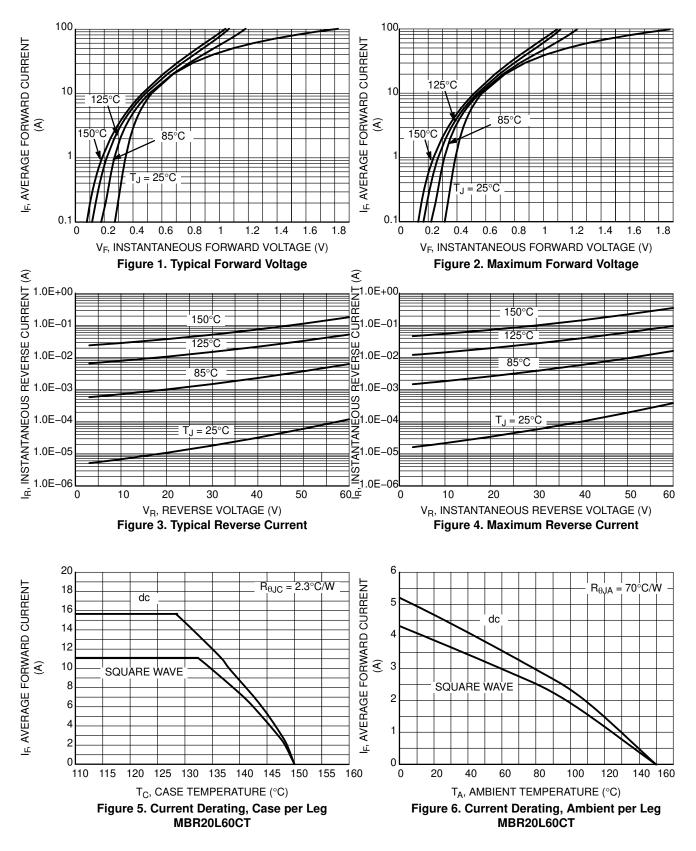
#### THERMAL CHARACTERISTICS

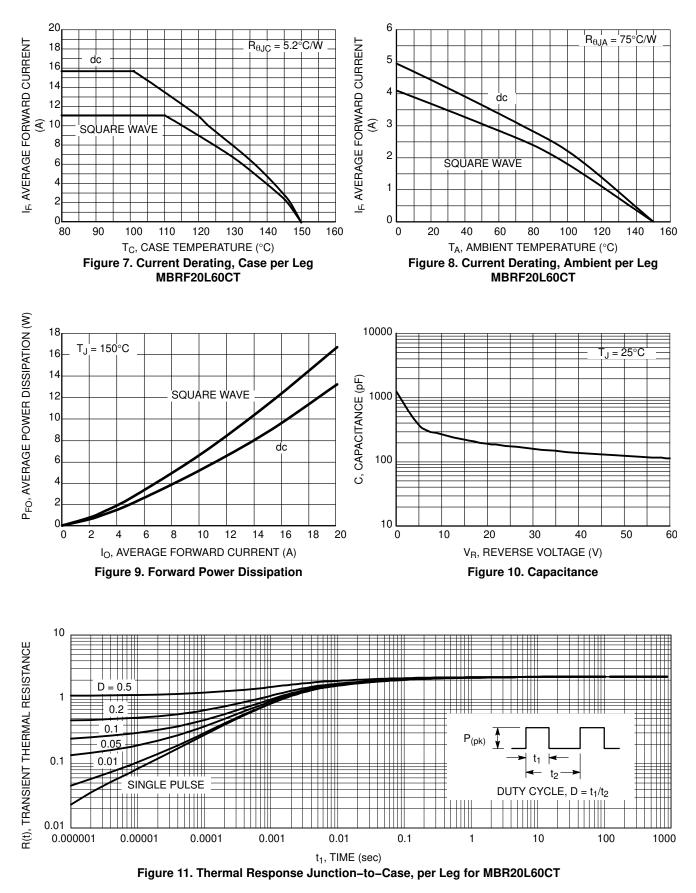
Charact	eristic	Symbol	Value	Unit
Maximum Thermal Resistance MBR20L60CTG MBRF20L60CTG	<ul> <li>Junction-to-Case</li> <li>Junction-to-Ambient</li> <li>Junction-to-Case</li> </ul>	R <sub>θJC</sub> R <sub>θJA</sub> R <sub>θJC</sub>	2.3 70 5.2	°C/W
	– Junction–to–Ambient	$R_{\theta JA}$	75	

#### ELECTRICAL CHARACTERISTICS (Per Diode Leg)

Characteristic	Symbol	Тур	Max	Unit
	VF	0.53 0.49 0.68 0.64	0.57 0.54 0.73 0.69	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C = 25^{\circ}C$ ) (Rated DC Voltage, $T_C = 125^{\circ}C$ )	i <sub>R</sub>	118 52	380 96	μA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .





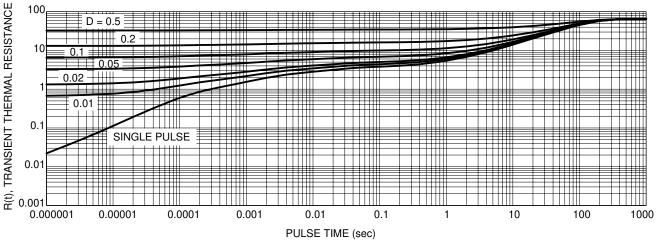
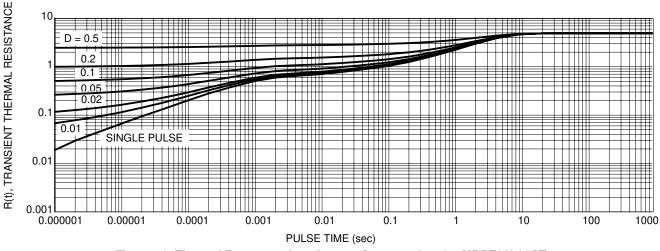
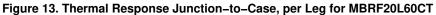


Figure 12. Thermal Response Junction-to-Ambient, per Leg for MBR20L60CT





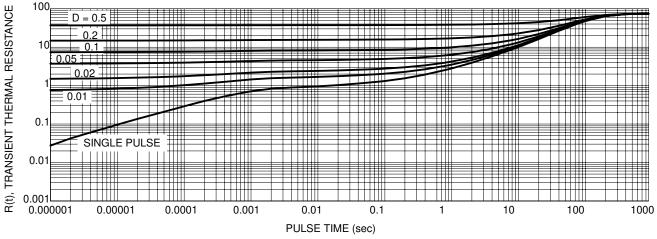
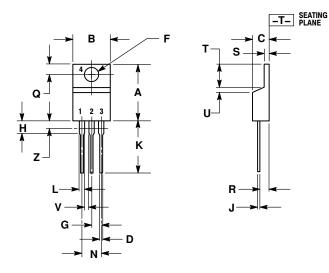


Figure 14. Thermal Response Junction-to-Ambient, per Leg for MBRF20L60CT

#### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH** 



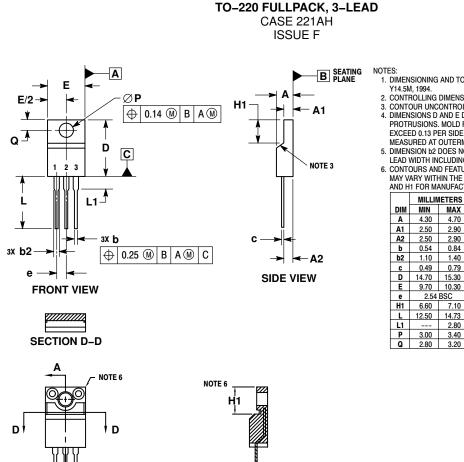
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
κ	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
۷	0.045		1.15	
Ζ		0.080		2.04

STYLE 6: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE

www.onsemi.com 6

#### PACKAGE DIMENSIONS



1. DIMENSIONING AND TOLERANCING PER ASME

- CONTROLLING DIMENSION: MILLIMETERS.
   CONTOUR UNCONTROLLED IN THIS AREA.
- MEASURED AT OUTERMOST EXTREME OF THE PLASTIC BODY. 5. DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION.
- LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2.00. 6. CONTOURS AND FEATURES OF THE MOLDED PACKAGE BODY
- MAY VARY WITHIN THE ENVELOP DEFINED BY DIMENSIONS A1 AND H1 FOR MANUFACTURING PURPOSES.

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